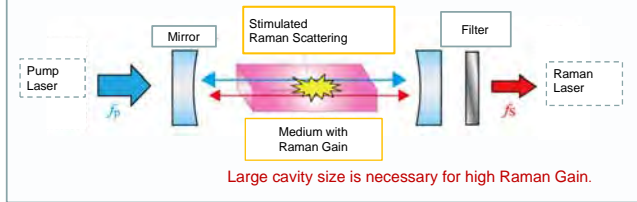


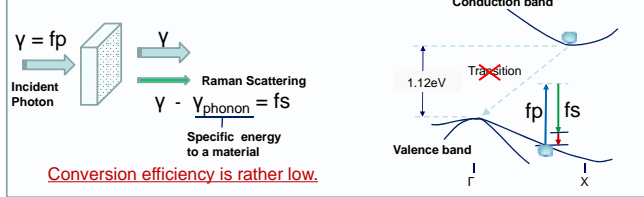
1. Silicon Raman Laser

- Raman laser is the only silicon laser, but
- Currently proposed Si laser needs the improvement
 - miniaturization to micrometer dimensions
 - reduction of the threshold to microwatt powers

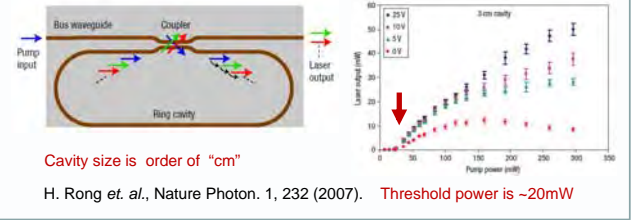
Stimulated Raman Scattering with cavity



Principle of Raman Scattering



Example of silicon Raman laser



2. Principle of the Invention

- To utilize two types of nanocavity mode in hetero nanocavity
- To fabricate the cavity along the [100] crystal direction

- Photon is localized in a cavity with a volume, $\sim \lambda^3$
- Q-value $> 10 \times 10^5$ in Odd nanocavity mode
 10×10^6 in Even nanocavity mode
- Δ of frequencies is tunable by the air-hole radius

$G_{[-]}$: Raman gain in each direction

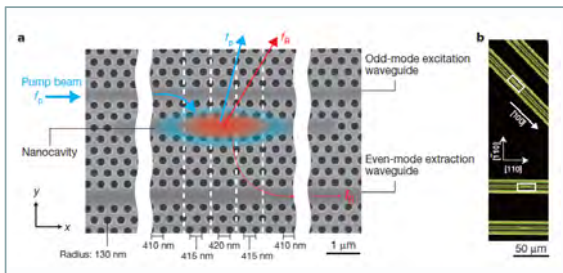
$$G_{[100]} \propto \iiint_{Si} |E_{x_Raman}^* E_{y_pump} + E_{y_Raman}^* E_{x_pump}|^2 dx dy dz$$

$$G_{[110]} \propto \iiint_{Si} |E_{x_Raman}^* E_{x_pump} - E_{y_Raman}^* E_{y_pump}|^2 dx dy dz$$

$G_{[100]} \gg G_{[110]}$, then [100] is favorable

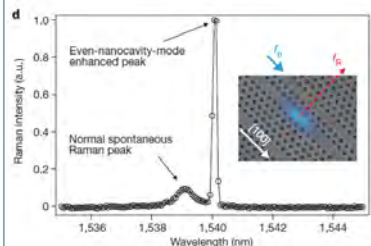
3. Characteristics

Both [100] & [110] devices are evaluated.

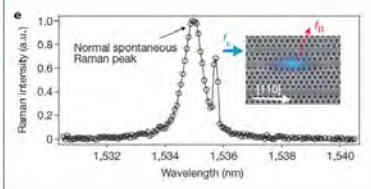


- Threshold power : 1uW, 20,000 times smaller.
- Chip size is 10,000 times smaller.

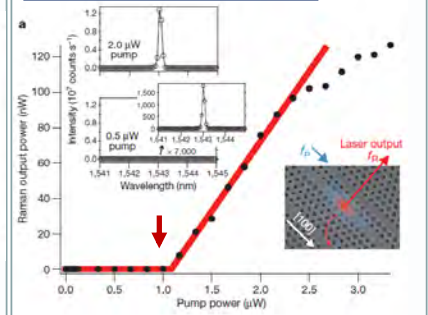
[100] device



[110] devices



Input - output characteristic

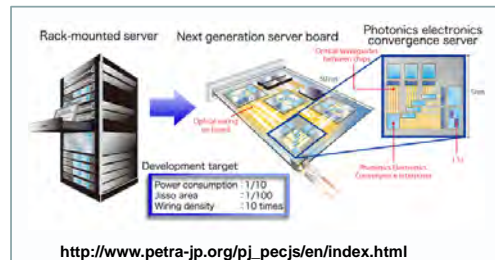


Chip size



4. Application Examples

- Realization of the convergence between photonics and electronics
- Various industrial applications
 - Laser with the current mode excitation is under development.



- Inter-chip connection (Interposer)
- O/E interface inside the chip

Patent Licensing Available

Patent No.: WO2014/030370

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